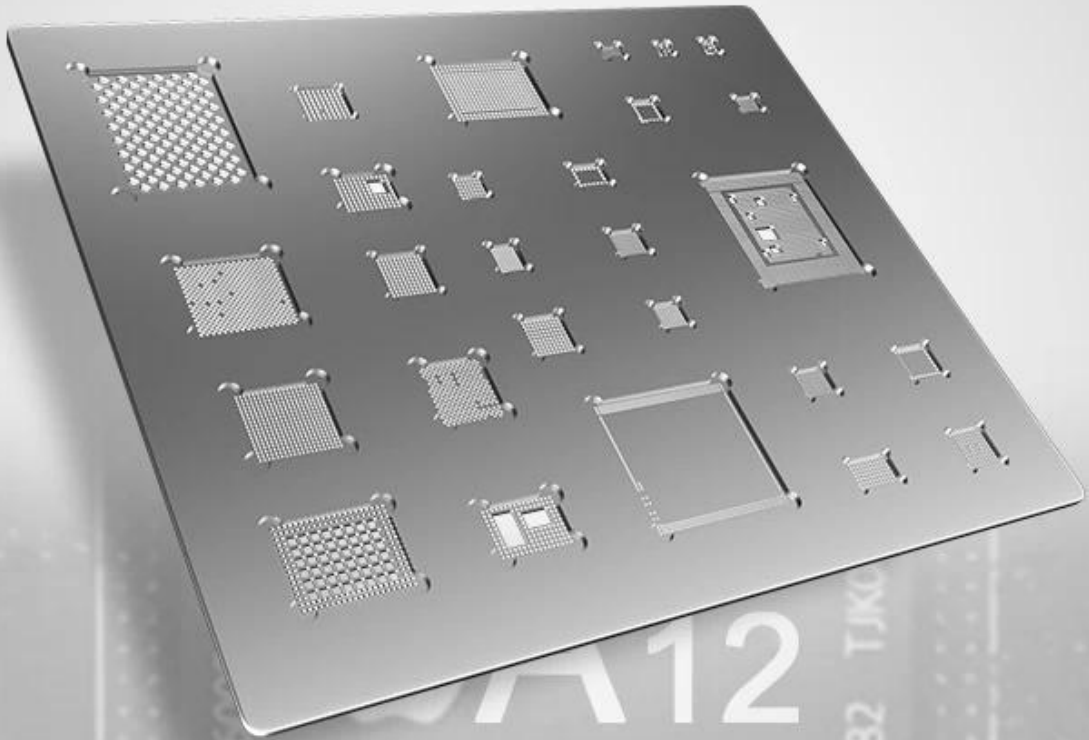


000000 0000

00000 00000 000000 000000 000 000000 BGA 000000 Iphone XS / XS MAX / XR. 0000 0 000000 00000 0 0000 00000 0 0000 000 00000 0 0000 000 0000 0 000000000000 000000 0 000000 0000 0 00000000 0000 0000.

# 3D GROOVE — REBALLING STENCIL —



SEMI-ETCHING PROCESS



COOLING HOLE DESIGN

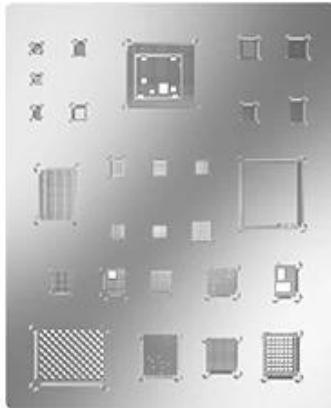


PRECISE ALIGNMENT



SQUARE HOLE

## Product Usage



MODEL	A12
WEIGHT	18.6g
MATERIAL	imported steel
SIZE	68.9 X 84.9mm
MATCHING MACHINE TYPE	iPhone XS/XS Max/XR

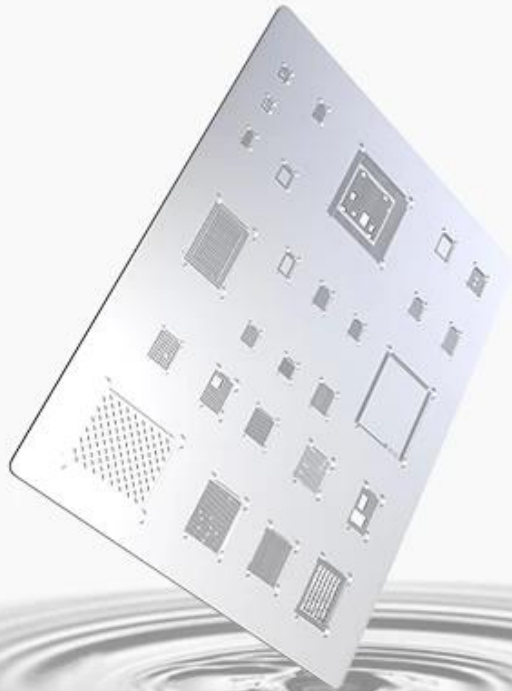
### ▼ CHARACTERISTICS

This product is used for BGA tinning repair of the iPhone XS/XS Max/XR series. Imported steel, anti-rolling anti-deformation, automatic alignment, accurate hole position, non-stick tin, good toughness, good off-grid.

---

## IMPORTED STEEL

HIGH TOUGHNESS



Easily mounted on the steel mesh to make the chip fit more closely with the mesh  
Therefore, the chip after tinning is "more precise"



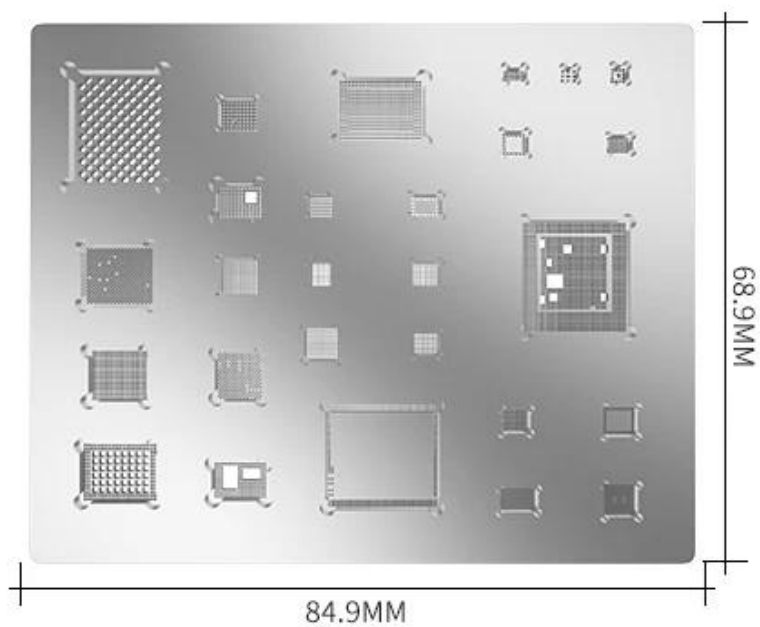
A112

A 3D rendering of an Apple A112 chip mounted on a steel mesh board. The chip is black with the Apple logo and the text "A112" in white. The mesh board is silver and has a grid pattern. The chip is mounted on the mesh, and the text "A112" is visible on the top surface of the chip.



Imported steel  
Hard and wear resistant  
Accurate to the hole

## PRODUCT SIZE



Thin to 0.33mm

Precise die-casting **form heating**



